

RoHS

K1342-VB Datasheet

N-Channel 900V (D-S) Super Junction Power MOSFET

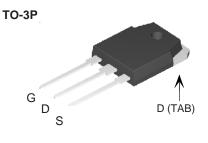
PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	900			
R _{DS(on)} at 25 °C (Ω)	$V_{GS} = 10 V$	0.75		
Q _g max. (nC)	20			
Q _{gs} (nC)	2.4			
Q _{gd} (nC)	11			
Configuration	Single			

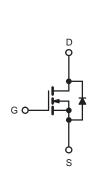
FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial





N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unl	less otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V _{DS}	900	V
Gate-Source Voltage			V _{GS}	± 30	v
Continuous Drain Current (T _J = 150 °C)	V _{GS} at 10 V	$T_C = 25 \text{ °C}$ $T_C = 100 \text{ °C}$		9	
	VGS at TO V	T _C = 100 °C	I _D	7.3	A
Pulsed Drain Current ^a			I _{DM}	28	
Linear Derating Factor				1.89	W/°C
Single Pulse Avalanche Energy ^b			E _{AS}	86	mJ
Maximum Power Dissipation			PD	109	W
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	°C
Drain-Source Voltage Slope	T _J = 125 °C		dV/dt	dt 50	V/ns
Reverse Diode dV/dt ^d			av/at	3.2	v/ns
Soldering Recommendations (Peak Temperature) ^c	for 10 s			300	°C

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature. b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 3.5 A.

c. 1.6 mm from case. d. $I_{SD} \le I_D$, dl/dt = 100 A/µs, starting $T_J = 25$ °C.

K1342-VB



THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	72	°C/W	
Maximum Junction-to-Case (Drain)	R _{thJC}	-	0.7	0/11	

PARAMETER	SYMBOL	TES	F CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static				•	•	•	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$		900	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	Reference to 25 °C, I _D = 1 mA		0.65	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$		2	-	4	V
Gate-Source Leakage	I _{GSS}	$V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA
		,	$V_{GS} = \pm 30 \text{ V}$		-	± 1	μA
		$V_{DS} = 900 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	-	1	† ·
Zero Gate Voltage Drain Current	I _{DSS}		$V_{DS} = 620 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 \text{ °C}$		-	10	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 6 A	-	0.75	-	Ω
Forward Transconductance	9 _{fs}	V _{DS} = 30 V, I _D = 6 A		-	19	-	S
Dynamic				•	•	•	
Input Capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	373	-	pF
Output Capacitance	C _{oss}			-	26	-	
Reverse Transfer Capacitance	C _{rss}			-	14	-	
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	- $V_{DS} = 0 V \text{ to } 520 V, V_{GS} = 0 V$		-	46	-	
Effective Output Capacitance, Time Related ^b	C _{o(tr)}			-	64	-	
Total Gate Charge	Qg			-	26		1
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V I _D = 6 A, V _{DS} = 520 V		-	2.1	-	nC
Gate-Drain Charge	Q _{gd}				2.8	-	
Turn-On Delay Time	t _{d(on)}			-	26	-	1
Rise Time	t _r	Voo	= 620 V, I _D = 6 A,	-	55.7	-]
Turn-Off Delay Time	t _{d(off)}		$V_{\rm GS} = 020$ V, $R_{\rm g} = 0.2$ Ω , V _{GS} = 10 V, $R_{\rm g} = 9.1 \Omega$		71	-	- ns
Fall Time	t _f	1		-	41	-	
Gate Input Resistance	Rg	f = 1 MHz, open drain		-	3.5	-	Ω
Drain-Source Body Diode Characteristic	s	-					
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	7	
Pulsed Diode Forward Current	I _{SM}			-	-	18	A
Diode Forward Voltage	V _{SD}	T _J = 25 °C, I _S = 6 A, V _{GS} = 0 V		-	-	1.4	V
Reverse Recovery Time	t _{rr}			-	192	-	ns
Reverse Recovery Charge	Q _{rr}	$T_J = 25 \text{ °C}, I_F = I_S = 6 \text{ A},$ dl/dt = 100 A/µs, V _R = 400 V		-	2.4	-	μC
Reverse Recovery Current	I _{RRM}			_	11	-	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} . b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .





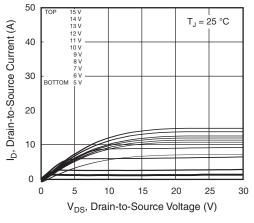


Fig. 1 - Typical Output Characteristics

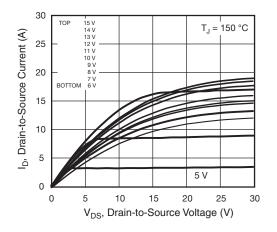


Fig. 2 - Typical Output Characteristics

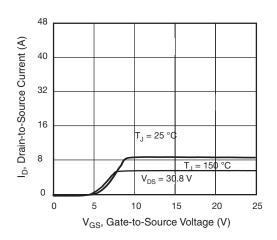


Fig. 3 - Typical Transfer Characteristics

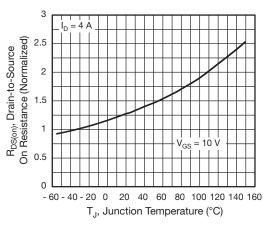


Fig. 4 - Normalized On-Resistance vs. Temperature

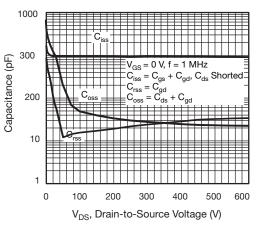


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

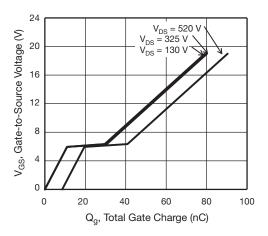


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



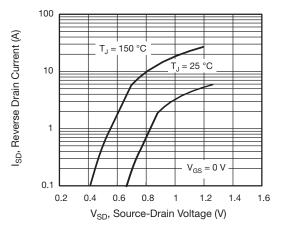


Fig. 7 - Typical Source-Drain Diode Forward Voltage

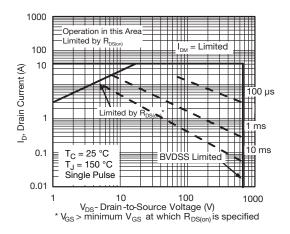


Fig. 8 - Maximum Safe Operating Area

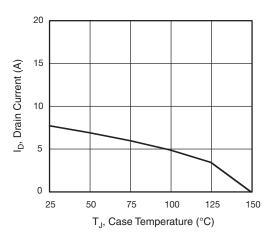


Fig. 9 - Maximum Drain Current vs. Case Temperature

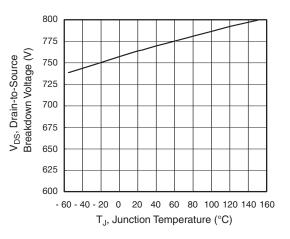


Fig. 10 - Temperature vs. Drain-to-Source Voltage

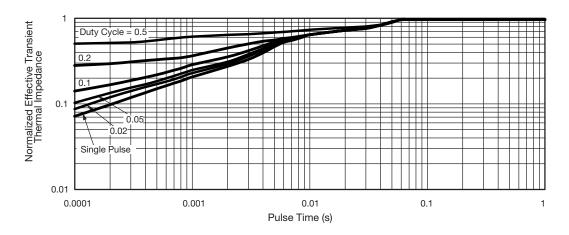


Fig. 11 - Normalized Thermal Transient Impedance, Junction-to-Case



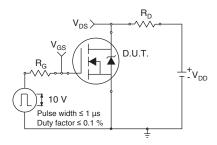


Fig. 12 - Switching Time Test Circuit



Fig. 13 - Switching Time Waveforms

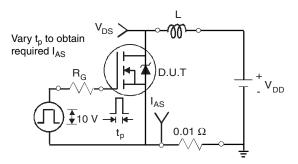


Fig. 14 - Unclamped Inductive Test Circuit



Fig. 15 - Unclamped Inductive Waveforms

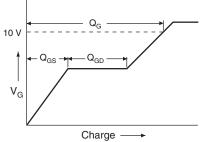


Fig. 16 - Basic Gate Charge Waveform

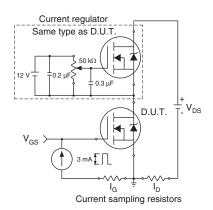
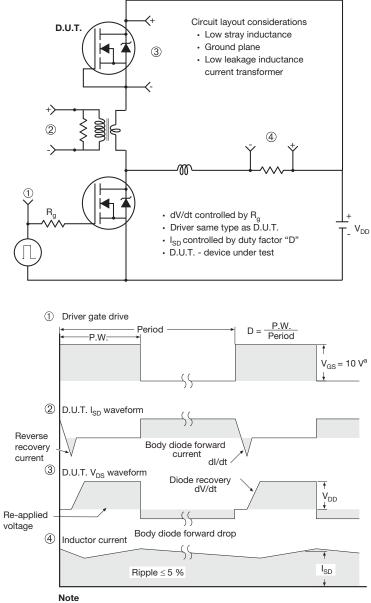


Fig. 17 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5$ V for logic level devices

Fig. 18 - For N-Channel



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